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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Abdurrahman Sezginer et al. PATENT APPLICATION

Serial No.: 10/074,561

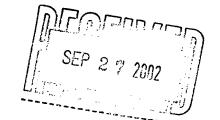
Group Art Unit: 2881

Filed: February 12, 2002

Examiner:

For: OVERLAY ALIGNMENT METROLOGY

USING DIFFRACTION GRATINGS



Information Disclosure Statement

Hon. Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

The following information is submitted in compliance with Applicants' duty of disclosure under 37 CFR § 1.56. A copy of each reference is enclosed.

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|-----------|----------------------|----------|-----------|------|-----------------|
| Pat. No. | <u>Patentee</u> | | 2800 | SEP | RECEIVI |
| | | | | - 1 | CH |
| 4,103,998 | Nakazawa et al. | 08/01/78 | <u> </u> | S | $ \overline{} $ |
| 4,172,664 | Charsky et al. | 10/30/79 | ات ا | 2002 | Œ) |
| 4,200,395 | Smith et al. | 04/29/80 | MAIL ROOM | | |
| 4,311,389 | Fay et al. | 01/19/82 | | | |
| 4,332,473 | Ono | 06/01/82 | | | |
| 4,703,434 | Brunner | 10/27/87 | | | |
| 4,757,207 | Chappelow et al. | 07/12/88 | | | |
| 5,100,237 | Wittekoek et al. | 03/31/92 | | | |
| 5,343,292 | Brueck et al. | 08/30/94 | | | |
| 5,608,526 | Piwonka-Corle et al. | 03/04/97 | | | |
| 5,721,607 | Ota | 02/24/98 | | | |
| 5,808,742 | Everett et al. | 09/15/98 | | | |
| | | | | | |

| 5,867,276 | McNeil et al. | 02/02/99 |
|-----------|-----------------|-----------------------|
| 5,889,593 | Bareket | 03/30/99 |
| 5,963,329 | Conrad et al. | 10/05/99 |
| 6,023,338 | Bareket | 02/08/00 SEP 2 7 7772 |
| 6,079,256 | Bareket | 07/27/00 ^L |
| 6,088,103 | Everett et al. | 07/11/00 |
| 6,100,985 | Scheiner et al. | 08/08/00 |
| 6,150,231 | Muller et al. | 11/21/00 |

Foreign Patent Documents

| Publ. No. | Country | Publ. Date |
|-------------|---------|----------------|
| WO 99/45340 | PCT | Sept. 10, 1999 |

Other References

N.T. Sullivan et al., "Semiconductor Pattern Overlay", Handbook of Critical Dimension Metrology and Process Control, Proceedings of conf. 28-29 Sept. 1993, Monterey, CA, K.M. Monahan, SPIE Optical Engineering Press, Vol. CR52, pp. 160-188.

Printout, Nikon KrF Step-and-Repeat Scanning System NSR-S205C, July 2000.

- A. Starikov et al., "Accuracy of Overlay Measurements: Tool and mark Asymmetry Effects", Optical Engineering, June 1992, Vol. 31, No. 6, pp. 1298-1310.
- J. Opsal et al., "Broadband Spectral Operation of a Rotating-Compensator Ellipsometer", *Thin Solid Films*, 1998, Vol. 313-314, pp. 58-61.
- X. Niu et al., "Specular Spectroscopic Scatterometry in DUV Lithography", SPIE, March 1999, Vol. 3677, pp. 159-168.
- R.M. Silver et al., "Overlay Metrology: Recent Advances and Future Solutions", Future Fab International, Issue 11, London, July 2001, 17 pages.

IBM Technical Disclosure Bulletin, March 90A 60854/GE8880210, pp. 170-174.

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CERTIFICATE OF MAILING

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Asst. Commissioner for Patents, Washington, D.C.

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Sally Azevedo

ate: August 28, 2002

Respectfully submitted,

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(408) 297-9733

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|---|---|---------------|---|-------------------|--------------|--------------|---------------------|--------------|----------------|--------|
| FORM | PTO- | 1 | Atty. Docke SEN-019 | | | | ial No. /074,561 | | | |
| | | RIOR ART | Applicant: Abdurrahman Sezginer et al. | | | | | | | |
| | | | Filing Date February 12 | | | | | | | |
| | | | U.S. | PATE | T DOCUMENTS | | <u> </u> | | | |
| Examiner Document Grant Initial* Number Date | | | | Name | | Class | | Sub Class | Filing Date | |
| | AA | 4,103,998 | 08/01/78 | Nakazawa et al. | | 356 | | 152 | | |
| | AB | 4,172,664 | 10/30/79 | Char | sky et al. | | 356 | 3 | 356 | |
| | AC | 4,200,395 | 04/29/80 | Smit | h et al. | | 356 | | 356 | |
| - | AD | 4,311,389 | 01/19/82 | Fay | et al. | | 356 | | 354 | |
| | AE | 4,332,473 | 06/01/82 | Ono | | | 356 | | 356 | |
| | AF | 4,703,434 | 10/27/87 | Brunner | | | 364 | | 488 | |
| | AG | 4,757,207 | 07/12/88 | Chappelow et al. | | 250 | | 491.1 | | |
| | AH 5,100,237 03/31/92 Witte | | ekoek et al. | | 356 40 | | 401 | | | |
| | AI | 5,343,292 | 08/30/94 | Brueck et al. | | | 356 363 | | 363 | |
| | AJ 5,608,526 03/04/97 Piw | | Piwo | onka-Corle et al. | | 356 36 | | 369 | | |
| | | | FOREIG | N PAT | ENT DOCUMENT | rs | | | | |
| Examiner Publ. Publ. Sub Initial* Number Date Country Class Class | | | | | | Trans Yes | slation No | | | |
| AK WO99/45340 4 09/10/99 PCT | | | | | | | | Х | | |
| | OTHE | ER ART (Inclu | ding Autho | r, Ti | tle, Date, E | Pertine | nt Pa | ges | , Etc. | .) |
| N.T. Sullivan et al., "Semiconductor Pattern Overlay", Handbook of Critical Dimension Metrology and Process Control, Proceedings of Conf. 28-29 Sept. 1993, Monterey, CA, K.M. Monahan, SPIE Optical Engineering Press, Vol. CR52, pp. 160-188. | | | | | | | | | | |
| | Printout, Nikon KrF Step-and-Repeat Scanning System NSR-S205C, AM July 2000. | | | | | | | | | 05C, |
| | A. Starikov et al., "Accuracy of Overlay Measurements: Tool and mark Asymmetry Effects", Optical Engineering, June 1992, Vol. 31, No. 6, pp. 1298-1310. | | | | | | | | | |
| | J. Opsal et al., "Broadband Spectral Operation of a Rotating- AO Compensator Ellipsometer", Thin Solid Films, 1998, Vol. 313-314, pp. 58-61. | | | | | | | | - | |
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*Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

| FORM : | PTO-1 | 1449 | P 0 3 2002 B | | Atty. Dock SEN-019 | et No. | | al No. | - | |
|-----------------|-----------------------------------|--|---------------|--------------------------------|--|--------------|--------------------|---------------|----------------|--|
| | | RIOR ART APPLICANT | TRADEMARK | | Applicant: Abdurrahman Sezginer et al. | | | | | |
| | | | | ···· | Filing Date: February 12, 2002 | | | Group: 2 7007 | | |
| | | | U.S. | PATE | NT DOCUMENTS | 3 | | 20 00 10 00 | ~M/ | |
| Exami: Initi | | Document Number | Grant Date | | Name | | Class | Sub Class | Filing Date | |
| | ва | 5,721,607 | 02/24/98 | Ota | | 355 | 53 | | | |
| | BB | 5,808,742 | 09/15/98 | Ever | ett et al. | | 356 | 363 | | |
| | вс | 5,867,276 | 02/02/99 | McNeil et al. | | | 356 | 445 | | |
| | BD | 5,889,593 | 03/30/99 | Bare | ket | | 356 | 445 | | |
| | BE | 5,963,329 | 10/05/99 | Conr | ad et al. | | 356 | 372 | | |
| | BF | 6,023,338 | 02/08/00 | Bareket Bareket Everett et al. | | 356 | 401 | | | |
| | BG | 6,079,256 | 06/27/00 | | | 73 | 105 | | | |
| | вн | 6,088,103 | 07/11/00 | | | | 356 355 | | | |
| | BI 6,100,985 08/08/00 Scheiner et | | iner et al. | 356 | | 381 | | | | |
| | BJ | 6,150,231 | 11/21/00 | Mull | ler et al. | | 438 | 401 | | |
| | | | FOREIG | N PAT | ENT DOCUMEN | TS | | | | |
| Exami Initi | | Document Number | Grant Date | Country Class | | Sub Class | Translation Yes No | | | |
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| | OTHE | R ART (Incl | uding Autho | r, Ti | tle, Date, | Pertine | nt Pag | es, Etc | .) | |
| | BL | X. Niu et al., "Specular Spectroscopic Scatterometry in DUV Lithography", SPIE, March 1999, Vol. 3677, pp. 159-168., R.M. Silver et al., "Overlay Metrology: Recent Advances and Future Solutions", Future Fab International, Issue 11, London, July 2001, 17 pages. IBM Technical Disclosure Bulletin, March 1990, 90A | | | | | | | JV | |
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